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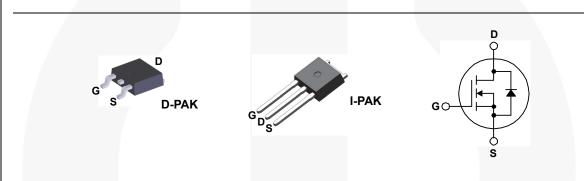
FQD1N80 / FQU1N80 N-Channel QFET® MOSFET 800 V, 1.0 A, 20 Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 5.5 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 2.7 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- 1.0 A, 800 V, R_{DS(on)} = 20 Ω (Max.) @ V_{GS} = 10 V, $I_{\rm D} = 0.5 \, {\rm A}$



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

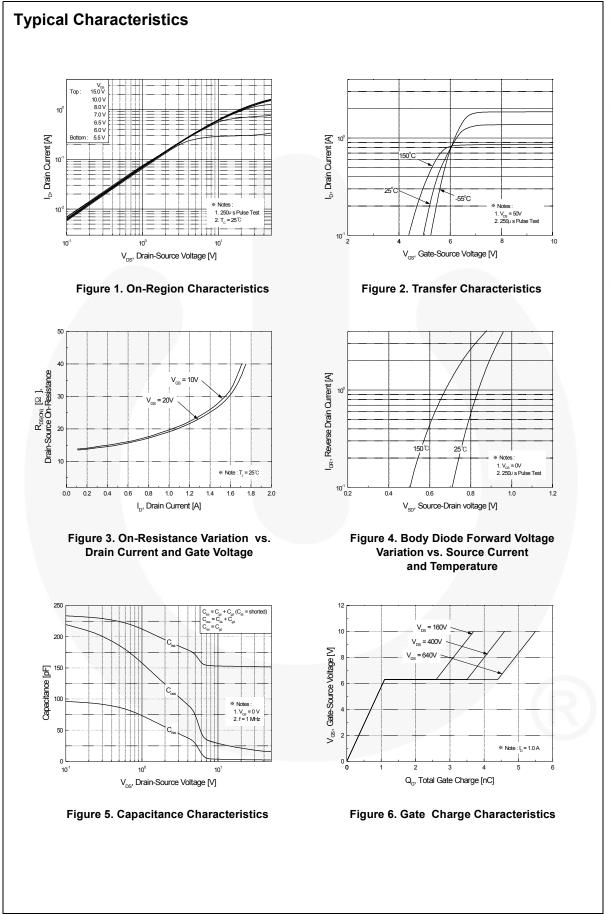
Symbol	Parameter		FQD1N80TM / FQU1N80TU	Unit V	
V _{DSS}	Drain-Source Voltage	800			
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)	1.0	А		
	- Continuous (T _C = 100°C)	0.63	А		
I _{DM}	Drain Current - Pulsed	(Note 1)	4.0	А	
V _{GSS}	Gate-Source Voltage	± 30	V		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		90	mJ	
I _{AR}	Avalanche Current (Note 1)		1.0	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		4.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns	
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$	2.5	W		
	Power Dissipation ($T_C = 25^{\circ}C$)	45	W		
	- Derate above 25°C	0.36	W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C		
ΤL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C	

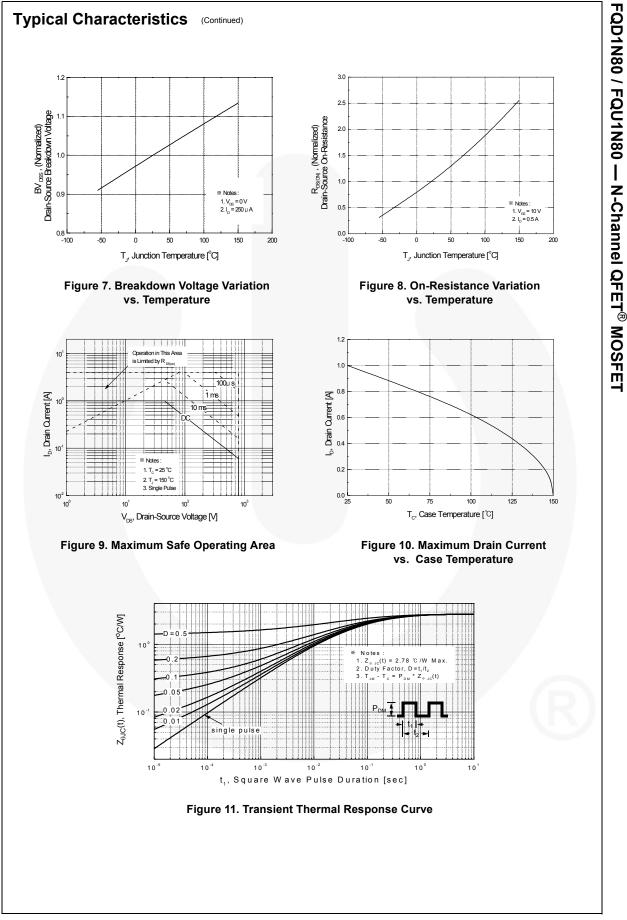
Thermal Characteristics

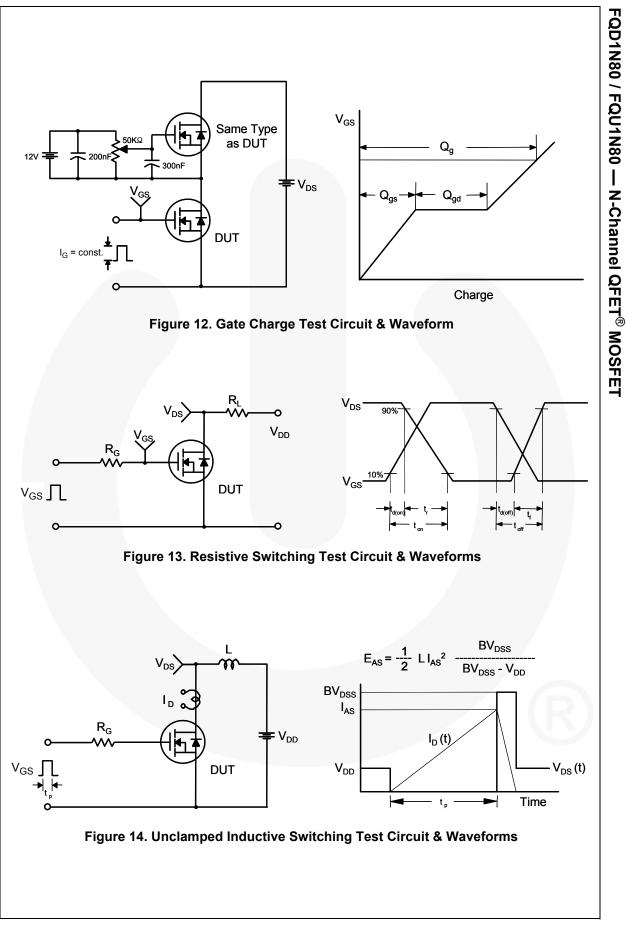
Symbol	Parameter	FQD1N80TM / FQU1N80TU	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	2.78	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	1

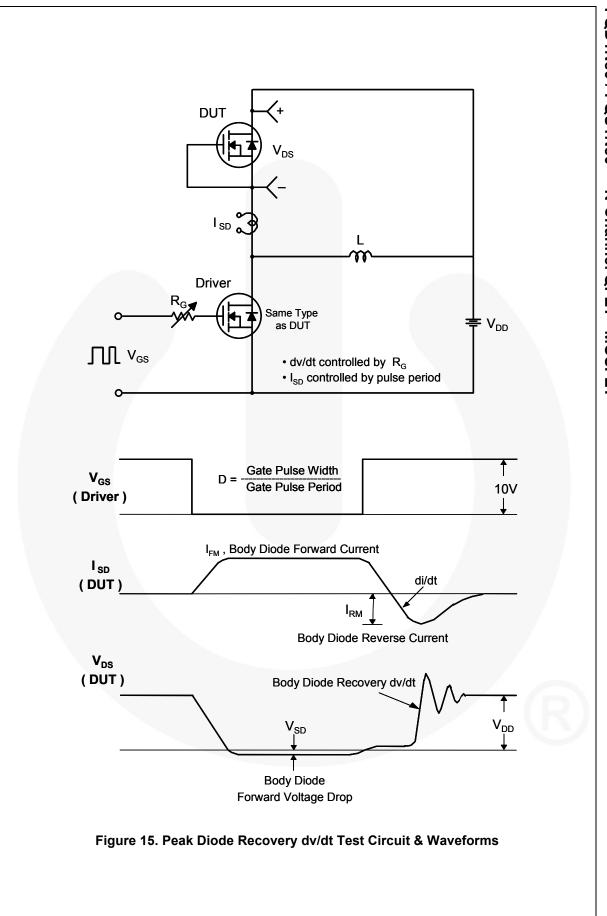
Part NumberTop MarkPackFQD1N80TMFQD1N80D-PFQU1N80TUFQU1N80I-PA		Top Mark Pack		age Packing Method Reel S		Size	Tape Width		Quantity		
		FQD1N80	D-P	AK	Tape and Reel		mm	16 mm		2500 units	
		AK Tube N/			A	N/A		70 units			
lectric	cal Cha	racteristics	T _C = 25°C	unless oth	herwise noted.						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max	. Unit	
Off Cha	aracterist	ics									
BV _{DSS}	1	irce Breakdown Volta	ige	V _{GS} =	0 V, I _D = 250 μA		800			V	
ABV _{DSS}		Breakdown Voltage Temperature		$I_D = 250 \mu$ A, Referenced to 25°C				1.0		V/°C	
$/\Delta T_J$	Coefficient										
I _{DSS}	Zero Gate Voltage Drain Current			$800 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$				10	μΑ		
		-	_	-	640 V, $T_C = 125^{\circ}C$				100	μΑ	
GSSF		y Leakage Current, F			30 V, V _{DS} = 0 V -30 V, V _{DS} = 0 V				100	nA	
GSSR	Gale-Bod	y Leakage Current, R	leverse	VGS =	-30 v, v _{DS} - 0 v				-100	nA	
On Cha	aracterist	ics									
V _{GS(th)}	Gate Thre	shold Voltage		V _{DS} =	V_{GS} , I_D = 250 μ A		3.0		5.0	V	
R _{DS(on)}		Static Drain-Source On-Resistance		$V_{GS} = 10 V, I_{D} = 0.5 A$				15.5	20	Ω	
9 _{FS}	Forward T	ransconductance		V _{DS} =	50 V, I _D = 0.5 A			0.75		S	
			_								
-	1	cteristics						1	1		
C _{iss}	Input Cap			V _{DS} = 25 V, V _{GS} = 0 V,			150	195	pF		
C _{oss}		apacitance		f = 1.0	f = 1.0 MHz			20	26	pF	
C _{rss}	Reverse 1	ransfer Capacitance						2.7	3.5	pF	
Switch	ing Chara	acteristics									
t _{d(on)}		Delay Time						10	30	ns	
t _r	Turn-On F	Rise Time			$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 1.0 \text{ A},$ R _G = 25 Ω			25	60	ns	
t _{d(off)}	Turn-Off D	Delay Time		NG - 2	10 32			15	40	ns	
()	Turn-Off F	all Time				(Note 4)		25	60	ns	
Qg	Total Gate	e Charge		V _{DS} =	640 V, I _D = 1.0 A.			5.5	7.2	nC	
	Gate-Sou	rce Charge		$V_{GS} =$				1.1		nC	
	Gate-Drai	n Charge				(Note 4)		3.3		nC	
t _f Q _g Q _{gs} Q _{gd}	Total Gate Gate-Sour	e Charge rce Charge		-	640 V, I _D = 1.0 A, 10 V			5.5 1.1	7.2		
		ode Characteris			•				4.0	•	
I _S			uous Drain-Source Diode Forward Current					1.0	A		
I _{SM}		Pulsed Drain-Source							4.0	A	
V _{SD}	Drain-Sou	rce Diode Forward V	oltage	V _{GS} = 0 V, I _S = 1.0 A				1.4	V		
	Dovorso E	Recovery Time		V _{GS} = 0 V, I _S = 1.0 A,			300		ns		
t _{rr} Q _{rr}	I Ceverse I				t = 100 A/μs						

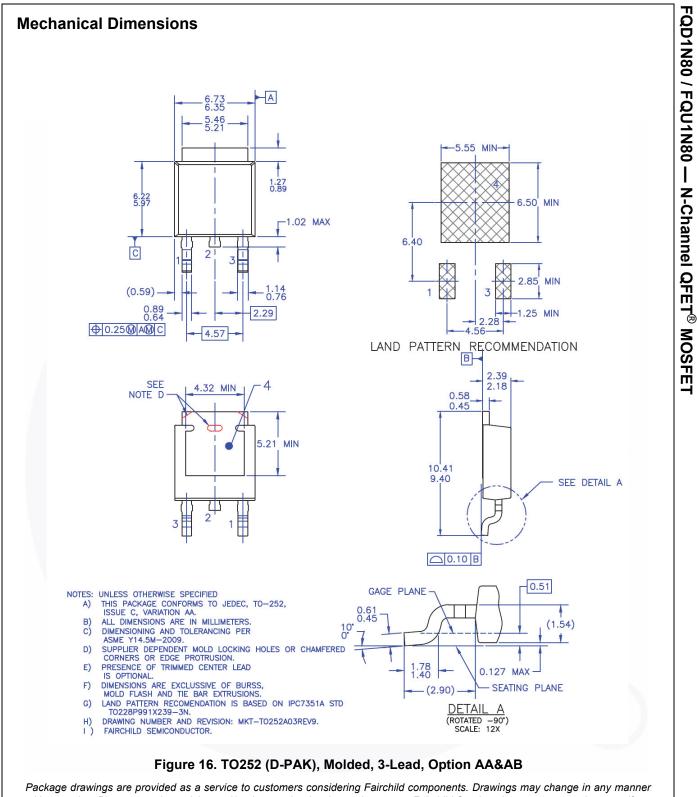
2. L = 170 min; $A_{S} = 1.0 \text{ A}$, $V_{DD} = 30 \text{ V}$; $A_{G} = 25 \Omega$; starting $T_{J} = 25^{\circ}$. 3. $I_{SD} \le 1.0 \text{ A}$, di/dt $\le 200 \text{ A/}\mu$ s, $V_{DD} \le BV_{DSS}$, starting $T_{J} = 25^{\circ}$ C. 4. Essentially independent of operating temperature. FQD1N80 / FQU1N80 — N-Channel QFET[®] MOSFET







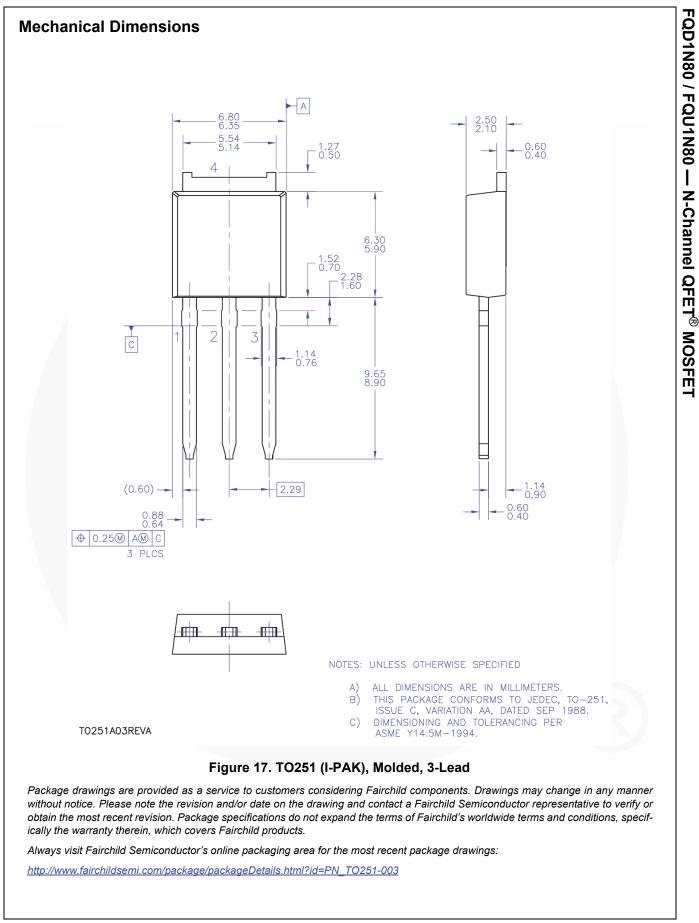




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